

HAT3015R

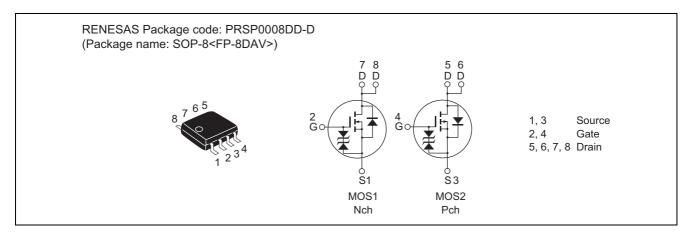
Silicon N/P Channel Power MOS FET High Speed Power Switching

REJ03G1368-0400 Rev.4.00 Apr 04, 2006

Features

- Low on-resistance
- Capable of 4 V gate drive
- High density mounting

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Rat | Heit | |
|--|-----------------------------|-------------|-------------|------|
| | | Nch | Pch | Unit |
| Drain to source voltage | V_{DSS} | 200 | -200 | V |
| Gate to source voltage | V_{GSS} | ±15 | ±15 | V |
| Drain current | I_D | 0.5 | -0.25 | Α |
| Drain peak current | I _{D(pulse)} Note1 | 2 | -1 | Α |
| Body-drain diode reverse drain current | I_{DR} | 0.5 | -0.25 | Α |
| Channel dissipation | Pch Note2 | 1.3 | 1.3 | W |
| | Pch Note3 | 2 | 2 | W |
| Channel temperature | Tch | 150 | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | -55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. 1 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s

3. 2 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s

Electrical Characteristics

• N Channel

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------------------------|---------------------|------|------|-----|----------|---|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 200 | | 1 | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±15 | _ | | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | 5 | μΑ | $V_{DS} = 200 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | 1.0 | _ | 2.1 | V | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ |
| Static drain to source on state | R _{DS(on)} | _ | 1.6 | 2.2 | Ω | $I_D = 0.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$ |
| resistance | R _{DS(on)} | _ | 1.9 | 2.7 | Ω | $I_D = 0.5 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note4}}$ |
| | R _{DS(on)} | _ | 2.4 | 5.5 | | $I_D = 2 \text{ A}, V_{GS} = 5 \text{ V}^{\text{Note4}}$ |
| Forward transfer admittance | y _{fs} | 0.56 | 0.86 | _ | S | $I_D = 0.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$ |
| Input capacitance | Ciss | _ | 120 | | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$ |
| Output capacitance | Coss | _ | 29 | | pF | |
| Reverse transfer capacitance | Crss | _ | 10 | _ | pF | |
| Turn-on delay time | t _{d(on)} | _ | 10 | | ns | $V_{GS} = 5 \text{ V}, I_D = 0.5 \text{ A},$ |
| Rise time | t _r | _ | 14 | _ | ns | $V_{DD} \cong 30 \text{ V}$ |
| Turn-off delay time | t _{d(off)} | _ | 24 | _ | ns | |
| Fall time | t _f | | 9 | | ns | |
| Body-drain diode forward voltage | V_{DF} | _ | 0.9 | 1.4 | V | $I_F = 0.5 \text{ A}, V_{GS} = 0^{\text{Note4}}$ |

Notes: 4. Pulse test

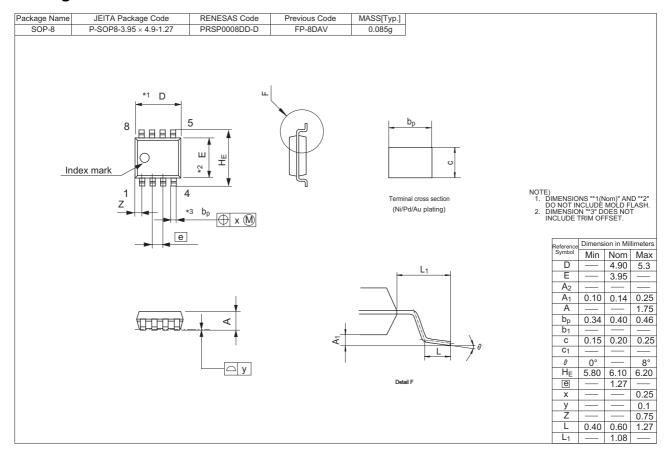
• P Channel

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------------------------|---------------------|------|------|------------|------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | -200 | _ | _ | V | $I_D = -10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±15 | _ | _ | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | - 5 | μΑ | $V_{DS} = -200 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | -1.0 | _ | -2.0 | V | $V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$ |
| Static drain to source on state | R _{DS(on)} | _ | 5.0 | 6.2 | Ω | $I_D = -0.25 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note5}}$ |
| resistance | R _{DS(on)} | _ | 6.0 | 7.5 | Ω | $I_D = -0.25 \text{ A}, V_{GS} = -4 \text{ V}^{\text{Note5}}$ |
| | R _{DS(on)} | _ | 7.0 | 10.0 | Ω | $I_D = -1 A, V_{GS} = -5 V^{Note5}$ |
| Forward transfer admittance | y _{fs} | 0.29 | 0.45 | _ | S | $I_D = -0.25 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note5}}$ |
| Input capacitance | Ciss | _ | 140 | _ | pF | $V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$ |
| Output capacitance | Coss | _ | 37 | _ | pF | |
| Reverse transfer capacitance | Crss | _ | 10 | _ | pF | |
| Turn-on delay time | t _{d(on)} | _ | 12 | _ | ns | $V_{GS} = -5 \text{ V}, I_D = -0.25 \text{ A},$ |
| Rise time | t _r | _ | 9 | _ | ns | $V_{DD} \cong -30 \text{ V}$ |
| Turn-off delay time | t _{d(off)} | _ | 25 | _ | ns | |
| Fall time | t _f | _ | 15 | _ | ns | |
| Body-drain diode forward voltage | V_{DF} | _ | -0.9 | -1.4 | V | $I_F = -0.25 \text{ A}, V_{GS} = 0^{\text{Note5}}$ |

Notes: 5. Pulse test

Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|---------------|----------|--------------------|
| HAT3015R-EL-E | 2500 pcs | Taping |

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